



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: TOKUNAGA, et al.

Serial No.: 10/764,563

Filed: January 27,2004

For: METHOD OF PURGING WAFER RECEIVING JIG, WAFER

TRANSFER DEVICE, AND METHOD OFMANUFACTURING

SEMICONDUCTOR DEVICE

## STATUS LETTER AND REQUEST FOR OFFICIAL FILING RECEIPT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 March 29, 2003

Sir:

Applicants note that the office of the undersigned has not received the Official Filing Receipt for the above-identified application and applicants respectfully request the Official Filing Receipt.

An early response to this request is earnestly solicited.

Respectfully submitted,

Antonelli, Terry, Stout & Kraus, LLP

William I. Solomon

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WIS/rr